

D/A Converter Series for Electronic Adjustments

Standard 8bit 8ch Type D/A Converters



BH2226FV, BH2226F

No.09052EBT05

●Description

The BH2226FV, BH2226F is an 8bit R-2R-type D/A converter with 8 channels. The D/A converter output and serial / parallel conversion function can be switched with one command, and a built-in RESET function ensures that the output voltage at all channels is Low during power up. A broad power supply voltage range (2.7V-5.5V) is available, providing design flexibility.

●Features

- 1) Integrated expansion port function
- 2) Built-in RESET function
- 3) High speed output response characteristics
- 4) 3-line-type serial interface
- 5) Broad power supply voltage range: 2.7V-5.5V

●Applications

DVCs, DSCs, DVDs, CD-Rs, CD-RWs

●Line up matrix

Parameter	BH2226FV	BH2226F
Power source voltage range	2.7~5.5V	2.7~5.5V
Number of channels	8ch	8ch
Current consumption	1.3 mA	1.3 mA
Differential non linearity error	±1.0LSB	±1.0LSB
Integral non linearity error	±1.5LSB	±1.5LSB
Output current performance	±1.0mA	±1.0mA
Settling time	100μs	100μs
Data transfer frequency	10MHz	10MHz
Input format	CMOS	CMOS
Data latch method	CSB method	CSB method
Package	SSOP-B16	SOP16

● Absolute Maximum Ratings

(Ta=25°C)

Parameter	Symbol	Limits	Unit	Remarks
Power source voltage	VCC	-0.3~7.0	V	-
Terminal voltage	VIN	-0.3~VCC	V	-
Storage temperature range	TSTG	-55~125	°C	-
Power dissipation	PD	450 ^{*1}	mW	BH2226FV
		500 ^{*2}	mW	BH2226F

*1 Derated at 4.5mW/ °C at Ta>25°C

*2 Derated at 5.0mW/ °C at Ta>25°C

*3 Please note that this product is not robust against radiation.

● Recommended Operating Conditions

(Ta=25°C)

Parameter	Symbol	Limits			Unit	Remarks
		MIN.	TYP.	MAX.		
VCC power source voltage	VCC	2.7	-	5.5	V	-
Terminal input voltage range	VIN	0	-	VCC	V	-
Analog output current	IO	-1.0	-	1.0	mA	-
Operating temperature range	TOPR	-20	-	85	°C	-
Serial clock frequency	FCLK	-	1.0	10.0	MHz	-
D/A output limit load capacity	CL	-	-	0.1	μF	-

● Electrical Characteristics

(Unless otherwise specified, VCC=3.0V, RL=OPEN, CL=0pF, Ta=25°C)

Parameter	Symbol	Limits			Unit	Conditions
		MIN.	TYP.	MAX.		
<Current consumption>						
VCC system	ICC	-	1.1	2.5	mA	CLK=1MHz, 80H setting
	ICCPD	-	5	20	μA	At power down setting
<Logic interface>						
L input voltage	VIL	GND	-	0.6	V	VCC=5V
H input voltage	VIH	2.4	-	VCC	V	VCC=5V
Input current	IIN	-10	-	10	μA	
L output voltage	VOL	-	-	0.4	V	IOH=2.5mA
H output voltage	VOH	VCC-0.4	-	-	V	IOL=0.4mA
<Buffer amplifier>						
Output zero scale voltage	ZS1	GND	-	0.1	V	00H setting, at no load
	ZS3	GND	-	0.3	V	00H setting, IOH=1.0mA
Output full scale voltage	FS1	VCC-0.1	-	VCC	V	FFH setting, at no load
	FS3	VCC-0.3	-	VCC	V	FFH setting, IOL=1.0mA
<D/A converter precision>						
Differential non linearity error	DNL	-1.0	-	1.0	LSB	Input code 02H~FDH
Integral non linearity error	INL	-1.5	-	1.5	LSB	Input code 02H~FDH
VCC power source voltage rise time	trVCC	100	-	-	μs	VCC=0→2.7V
Power on reset release voltage	VPOR	-	1.9	-	V	

● Timing Chart

(Unless otherwise specified, VCC=3.0V, RL=OPEN, CL=0pF, Ta=25°C)

Parameter	Symbol	Limits			Unit	Conditions
		MIN.	TYP.	MAX.		
CLK L level time	tCLKL	50	-	-	ns	
CLK H level time	tCLKH	50	-	-	ns	
DI setup time	tsDI	20	-	-	ns	
DI hold time	thDI	40	-	-	ns	
Parallel input setup time	tsPI	20	-	-	ns	
Parallel input hold time	thPI	40	-	-	ns	
CSB setup time	tsCSB	50	-	-	ns	
CSB hold time	thCSB	50	-	-	ns	
CSB H level time	tCSBH	50	-	-	ns	
D/A output settling time	tOUT	-	-	100	μs	CL=50pF, RL=10kΩ
Parallel output delay time	tpOUT	-	-	600	ns	CL=50pF, RL=10kΩ
Serial output delay time	tsOUT	-	-	350	ns	CL=50pF, RL=10kΩ

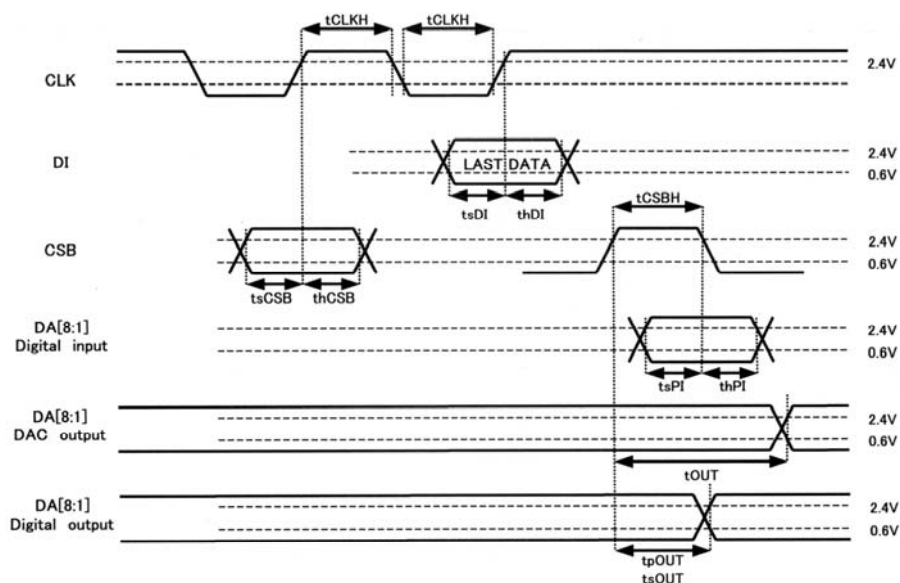


Fig.1

●Terminal Description / Block Diagrams

(BH2226FV,BH2226F)

No.	Terminal name	Function
1	DA1	Analog output terminal / I/O input output terminal
2	DA2	
3	DA3	
4	DA4	
5	DA5	
6	DA6	
7	DA7	
8	DA8	
9	VCC	Power source terminal
10	RESETB	Reset terminal
11	TEST	Test terminal (normal connected to GND)
12	CSB	Chip select signal input terminal
13	CLK	Serial clock input terminal
14	DI	Serial data input terminal
15	SO	Serial data output terminal
16	GND	Ground terminal

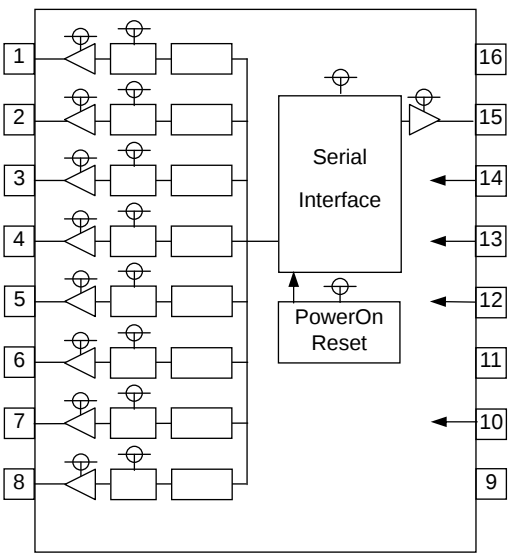


Fig.2

●Input-Output equivalence circuits

Terminal	Equivalence Circuit	Terminal	Equivalence Circuit
DA1 DA2 DA3 DA4 DA5 DA6 DA7 DA8		DI CLK CSB TEST RESETB	
		SO	

Fig.3 Input-Output equivalence circuits

●Operation Description

• Command Transmission

The Control command consists of 3 lines of 12bit serial input data (MSB first).

DI data is read at the rising edge of the CLK, and becomes valid in the CSB Low area (before the CSB rise for 12bit data).

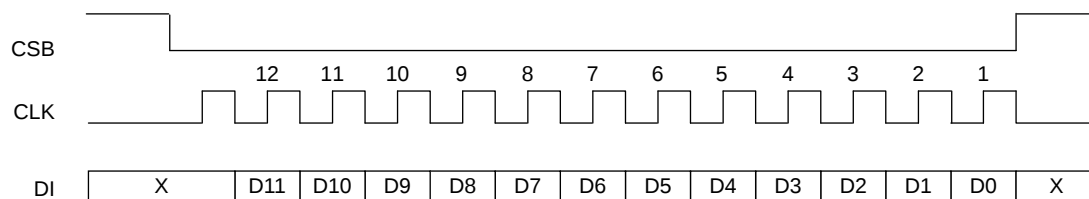


Fig.4

Data Settings

D0	D1	D2	D3	D4	D5	D6	D7	Setting
0	0	0	0	0	0	0	0	At D/A setting : GND
1	0	0	0	0	0	0	0	At D/A setting : (VCC-GND)/256x1
0	1	0	0	0	0	0	0	At D/A setting : (VCC-GND)/256 x 2
1	1	0	0	0	0	0	0	At D/A setting : (VCC-GND)/256 x 3
0	0	1	0	0	0	0	0	At D/A setting : (VCC-GND)/256 x 4
~								~
0	1	1	1	1	1	1	1	At D/A setting : (VCC-GND)/256 x 254
1	1	1	1	1	1	1	1	At D/A setting : (VCC-GND)/256 x 255

(Note) Default D[7:0]=00h

Channel Settings

D8	D9	D10	D11	Setting
0	0	0	0	Power down setting (default)
0	0	0	1	DA1
0	0	1	0	DA2
0	0	1	1	DA3
0	1	0	0	DA4
0	1	0	1	DA5
0	1	1	0	DA6
0	1	1	1	DA7
1	0	0	0	DA8
1	0	0	1	Power down release
1	0	1	0	Inconsequential
1	0	1	1	Inconsequential
1	1	0	0	I/O D/A select
1	1	0	1	I/O serial⇒Parallel
1	1	1	0	I/O parallel⇒Serial
1	1	1	1	I/O status setting

Input / Output D/A Selection settings : Each channel can be set for either I/O port or D/A converter output.

0: I/O mode (When I/O mode is selected, set the status as well.)

1: D/A mode (Set the I/O status to output mode.)

D0	D1	D2	D3	D4	D5	D6	D7	Description
DA1	DA2	DA3	DA4	DA5	DA6	DA7	DA8	Corresponding terminals for I/O or D/A selection

I/O Status Setting : Set the status of the I/O input output terminal by D0 ~ D7.

0: input mode (High-Z status)

1: output mode

D0	D1	D2	D3	D4	D5	D6	D7	Description
DA1	DA2	DA3	DA4	DA5	DA6	DA7	DA8	Corresponding terminals for status setting

- Command Transmission Procedures

Carry out the following after power on and just after external reset:

- (1) Power Down Release (2) I/O D/A Select (3) I/O Status Set

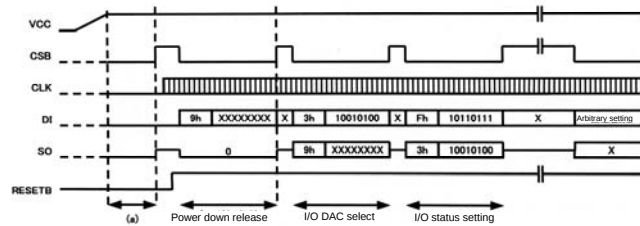


Fig.5

Note: When power is started, the power on reset is activated and the internal register initialized. However, as shown in the figure above, in area (a), if CSB cannot be made High and noise is introduced in the control line an error may occur when setting during the rising CSB signal.

In such a case, set the external RESETB terminal to Low and reset when CSB = High.

- Parallel - Serial Conversion

Parallel data {DA[8:1]} is taken in at the first CSB falling edge after setting the parallel serial command.

The data is then outputted in synch with the falling edge of the CLK in the next CSB = Low area, and output from 4CLK. However, please note that the SCLK falling edge that occurs from CSB fall to the first SCLK rising edge is not counted.

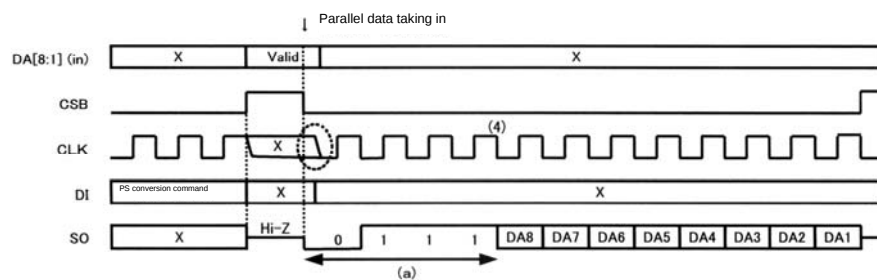


Fig.6

- Serial - Parallel Conversion

DI serial data is taken in at the rising edge of the CLK.

The data is then output from the DA[8:1] terminal just after the CSB rising edge.

During that time the SO terminal output becomes undetermined (just previous address setting + data output).

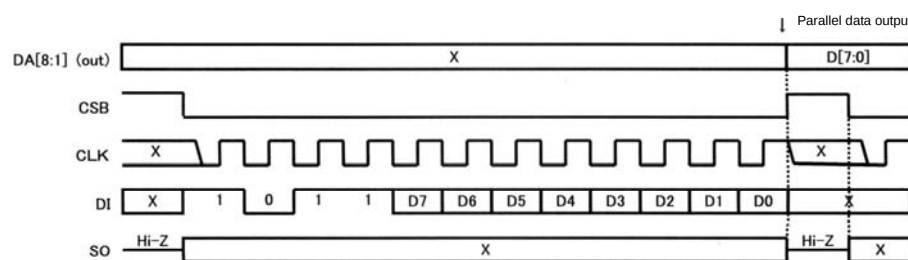


Fig.7

- D/A Converter Output Setting (Fig. 7)

DI serial data is taken in at the rising edge of the clock.

The D/A converter output is output from the DA[8:1] terminal just after the rising edge of the CSB.

During that time, the SO terminal output becomes undetermined (just previous address setting + data output).

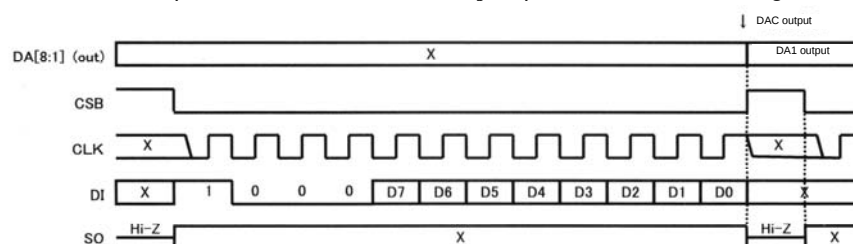


Fig.8

●Electrical Characteristics Curves

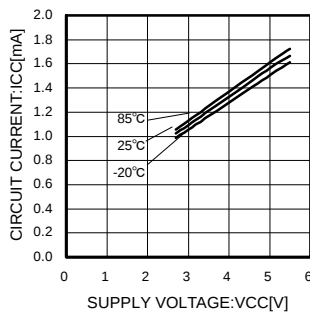


Fig.9 Action current consumption

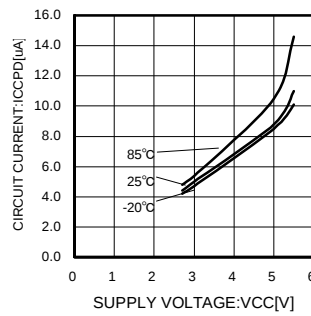


Fig.10 Consumption current at power down

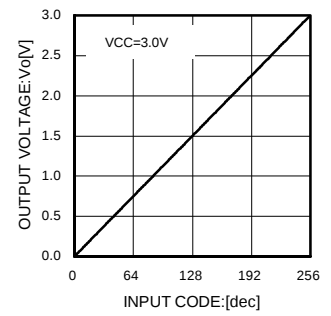


Fig.11 Output voltage characteristic

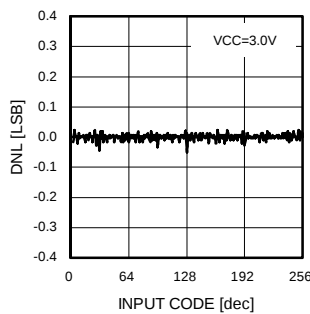


Fig.12 Differential non linearity error

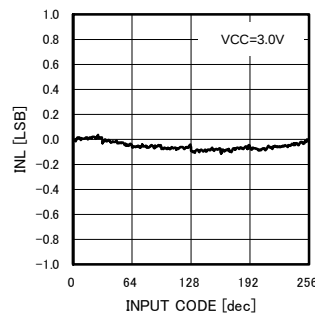


Fig.13 Integral non linearity error

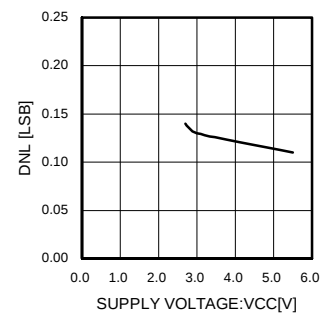


Fig.14 Power source voltage vs. differential non linearity error

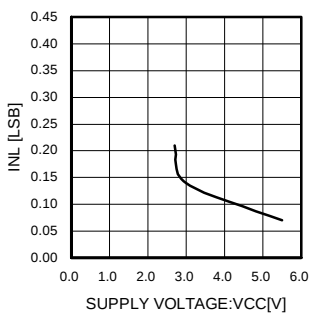


Fig.15 Power source voltage vs. integral non linearity error

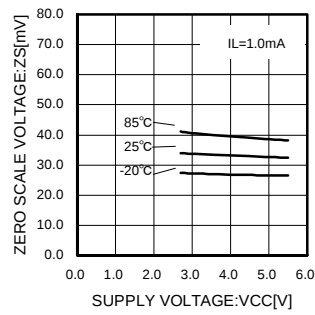


Fig.16 Output zero scale voltage

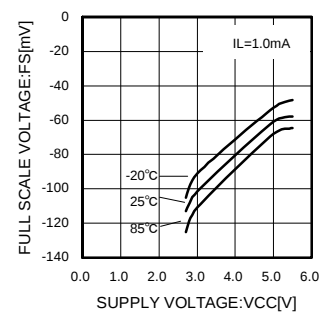


Fig.17 Output full scale voltage

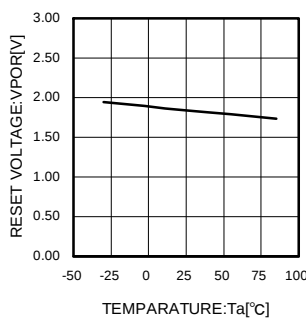


Fig.18 Reset release voltage

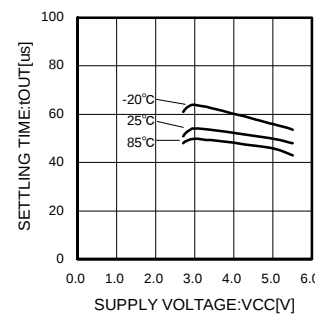


Fig.19 Settling time

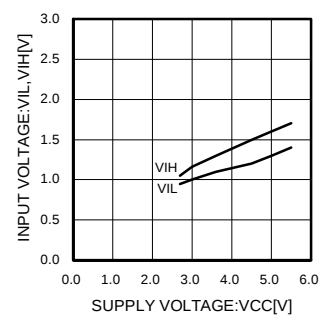


Fig.20 Input voltage

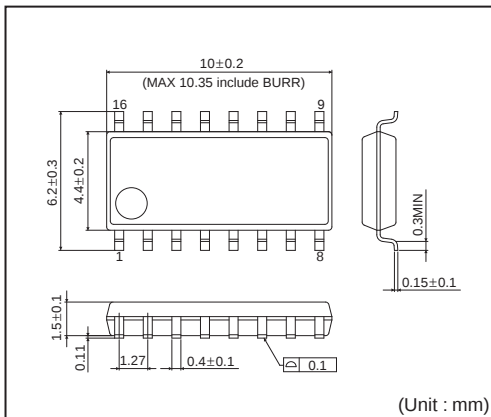
● Operation Notes

- (1) Numbers and data in entries are representative design values and are not guaranteed values of the items.
- (2) Although we are confident in recommending the sample application circuits, carefully check their characteristics further when using them. When modifying externally attached component constants before use, determine them so that they have sufficient margins by taking into account variations in externally attached components and the Rohm LSI, not only for static characteristics but also including transient characteristics.
- (3) Absolute Maximum Ratings
Operating or testing the device over the maximum specifications may damage the part itself as well as peripheral components. Therefore, please ensure that the specifications are not exceeded.
- (4) GND potential
Ensure that the GND terminal is at the lowest potential under all operating conditions.
- (5) Thermal design
Use a thermal design that allows for a sufficient margin regarding power dissipation (Pd) under actual operating conditions.
- (6) Terminal shorts and mis-mounting
Incorrect orientation or misalignment of the IC when mounting to the PCB may damage part. Short-circuits caused by the introduction of foreign matter between the output terminals or across the output and power supply or GND may also result in destruction.
- (7) Operation in a strong magnetic field
Operation in a strong electromagnetic field may cause malfunction.
- (8) Reset Function
The power on reset circuit, which initializes internal settings, may malfunction during abrupt power ons. Therefore, set the time constant so as to satisfy the power source rise time.
- (9) After power on and after the external reset is in power down status, DA1 ~ DA8 will be in input mode (all terminals at High-Z).
- (10) In the case of condition changes in the DA1 ~ DA8 terminals (i.e. changes from D/A mode to serial-parallel mode, from serial-parallel mode to parallel-serial mode, excluding D/A data and I/O data updates), change both analog and digital settings of High-Z.
- (11) Connect the RESETB terminal to VCC and set it to High, making sure that it becomes Low only at reset.
- (12) Initialization of the serial interface shift register is carried out only by power on reset, or external reset, and is not reset by CSB = High. Therefore, when a specified clock number (12CLK) is not attained during command setting, interrupting processing, transfer regular data once again.
- (13) The power down function restricts the consumption current in the internal analog circuit. Set it by command. At power down, for channels set to D/A mode, "I/O D/A selection" is changed from "D/A mode" to "I/O mode". Therefore, when the "I/O status setting" of the channel is in input mode, the terminal is in High-Z status and the input becomes unstable and unnecessary current flows. Set the I/O status setting of channel to be in output mode, or set the terminal using resistance.
- (14) When shifting from PIO use status to D/A use status, a wait time in order to ensure D/A output stability is necessary. Therefore wait for a maximum of 1ms after the "I/O D/A select" command is input.
If wait time is problematic, set the D/A setting code to 80hex and change it to the specified code setting.

●Ordering part number

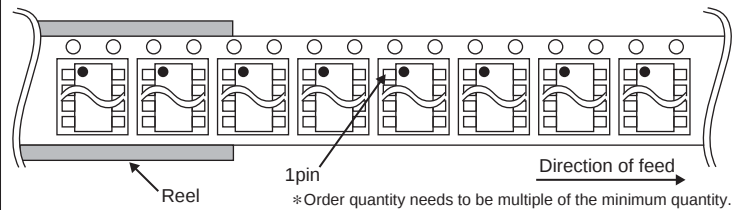
B H	2 2 2 6	F V	- E 2
Part No.	Part No.	Package FV: SSOP-B16 F: SOP16	Packaging and forming specification E2: Embossed tape and reel (SSOP-B16/SOP16)

SOP16

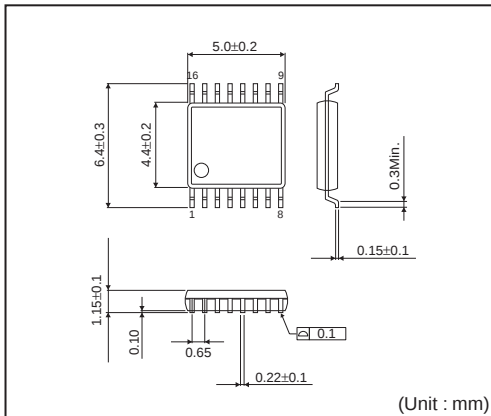


<Tape and Reel information>

Tape	Embossed carrier tape
Quantity	2500pcs
Direction of feed	E2 (The direction is the 1pin of product is at the upper left when you hold reel on the left hand and you pull out the tape on the right hand)

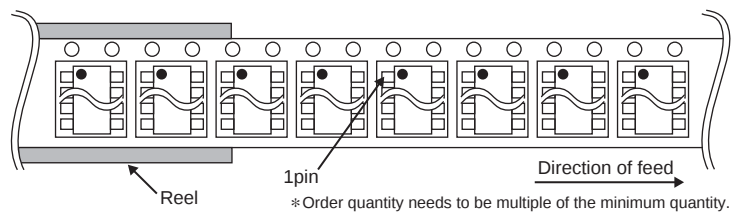


SSOP-B16



<Tape and Reel information>

Tape	Embossed carrier tape
Quantity	2500pcs
Direction of feed	E2 (The direction is the 1pin of product is at the upper left when you hold reel on the left hand and you pull out the tape on the right hand)



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